## **EAST Search History**

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	11299	385/14,88-94,130-132.ccls.	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/04/15 16:47
L2	2960	(substrate or wafer or board) and layer and interconnect and (waveguide or (wave near guide)) and (emit\$6 or transmit\$4) and (receiv\$5 or detect\$5) and light	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/04/15 16:59
L3	577	L1 and L2	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/04/15 16:50
L5	2	((substrate or wafer or board) and layer and interconnect and (waveguide or (wave near guide)) and (emit\$6 and transmit\$4) and (receiv\$5 and detect\$5) and light and resin ).clm.	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/04/15 16:58
L6	10	((substrate or wafer or board) and layer and interconnect and (waveguide or (wave near guide)) and (emit\$6 and transmit\$4) and (receiv\$5 and detect\$5) and light ). clm.	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/04/15 16:58
L7	931	"385"/\$6.ccls. and (substrate or wafer or board) and layer and (interconnect\$6 or wiring or conductor\$4 or contacts) and (waveguide or (wave near guide)) and (emit\$6 or transmit\$4) and (receiv\$5 or detect\$5) and electric\$4 and (optic\$4 or light) and resin	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/04/15 17:04
S1	1	10/691085	US-PGPUB; USPAT; EPO; JPO	OR	ON	2006/01/21 18:30
S2	<b>1</b>	10/691085 and (insulating near substrate)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2006/01/21 18:33
S3	1	10/691085 and (resin near layer)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2006/01/21 18:37
S4	1	10/691085 and (wave near guide)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2006/01/21 18:43
S5	9844	385/14,88-94,130-132.ccls.	US-PGPUB; USPAT; EPO; JPO	OR	ON	2006/01/21 18:44

## **EAST Search History**

S6	2392	(substrate or wafer or board) and layer and interconnect and (waveguide or (wave near guide)) and (emit\$6 or transmit\$4) and (receiv\$5 or detect\$5) and light	US-PGPUB; USPAT; EPO; JPO	OR	ON	2006/01/21 18:47
S7	467	S5 and S6	US-PGPUB; USPAT; EPO; JPO	OR	ON	2006/06/28 12:16
S8	81	S5 and S6 and (resin)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2006/01/22 13:24
S9	10434	385/14,88-94,130-132.ccls.	US-PGPUB; USPAT; EPO; JPO	OR	ON	2006/06/28 12:16
S10	2603	(substrate or wafer or board) and layer and interconnect and (waveguide or (wave near guide)) and (emit\$6 or transmit\$4) and (receiv\$5 or detect\$5) and light	US-PGPUB; USPAT; EPO; JPO	OR	ON	2006/06/28 12:16
S11	519	S9 and S10	US-PGPUB; USPAT; EPO; JPO	OR	ON	2006/12/22 10:52
S12	10965	385/14,88-94,130-132.ccls.	US-PGPUB; USPAT; EPO; JPO	OR	ON	2006/12/22 10:52
S13	2819	(substrate or wafer or board) and layer and interconnect and (waveguide or (wave near guide)) and (emit\$6 or transmit\$4) and (receiv\$5 or detect\$5) and light	US-PGPUB; USPAT; EPO; JPO	OR	ON	2006/12/22 10:52
S14	551	S12 and S13	US-PGPUB; USPAT; EPO; JPO	OR	ON	2007/04/15 16:47